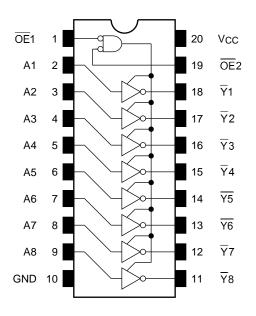
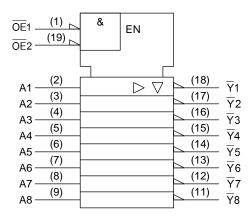


Pin Assignment (top view)



IEC Logic Symbol



Truth Table

	Inputs		Outputo
OE1	OE2	An	Outputs
Н	Х	Х	Z
Х	Н	Х	Z
L	L	Н	L
L	L	L	Н

X: Don't care

Z: High impedance



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	Vcc	-0.5 to 7.0	V
DC input voltage	VIN	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	Vout	-0.5 to V _{CC} + 0.5 (Note 3)	V
Input diode current	lıĸ	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC Vcc/ground current	ICC/IGND	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Dower oupply voltage	Voc	1.65 to 3.6	V	
Power supply voltage	Vcc	1.5 to 3.6 (Note 2)		
Input voltage	VIN	0 to 5.5	V	
Output valtage	\/	0 to 5.5 (Note 3)	V	
Output voltage	Vout	0 to Vcc (Note 4)	V	
Output ourropt	lou/lou	±24 (Note 5)	mA	
Output current	IOH/IOL	±12 (Note 6)	MA	
Operating temperature	T _{opr}	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5: VCC = 3.0 to 3.6 V

Note 6: VCC = 2.7 to 3.0 V

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Note 7: VIN = 0.8 to 2.0 V, VCC = 3.0 V



Electrical Characteristics

DC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characterist	Characteristics Symbol Test Condition				Min	Max	Unit				
Characteriot		Cymbol	Vcc (Vcc (V)		Wax	Onit			
					1.65 to 2.3	V _{CC} × 0.9	_				
	H-level	VIH	_	_		1.7	_				
Innut voltogo					2.7 to 3.6	2.0		V			
Input voltage					1.65 to 2.3	_	V _{CC} × 0.1	V			
	L-level	VIL	_		2.3 to 2.7	_	0.7				
					2.7 to 3.6	_	0.8				
				I _{OH} = -100 μA	1.65 to 3.6	V _{CC} -0.2	_				
				IOH = -4 mA	1.65	1.05	_				
	I I I I I I I I I I I I I I I I I I I	V	\(\frac{1}{2}\)	IOH = -8 mA	2.3	1.7	_	. V			
	H-level	Voн	VIN = VIH or VIL	I _{OH} = -12 mA	2.7	2.2	_				
				IOH = -18 mA	3.0	2.4					
Outract walks as				IOH = -24 mA	3.0	2.2	_				
Output voltage				I _{OL} = 100 μA	1.65 to 3.6	_	0.2				
				IOL = 4 mA	1.65	_	0.45				
				I _{OL} = 8 mA	2.3	_	0.7				
	L-level	Vol	VIN = VIH or VIL	I _{OL} = 12 mA	2.7		0.4				
							IOL = 16 mA	3.0	_	0.4	
				I _{OL} = 24 mA	3.0	_	0.55				
Input leakage current		liN	V _{IN} = 0 to 5.5 V	V _{IN} = 0 to 5.5 V			±5.0	μΑ			
3-state output off-state	e current	loz	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 5.5 \text{ V}$		1.65 to 3.6	_	±5.0	μА			
Power off leakage curr	rent	loff	V _{IN} /V _{OUT} = 5.5 V		0	_	10.0	μΑ			
			V _{IN} = V _{CC} or GND		1.65 to 3.6	_	10.0				
Quiescent supply current		Icc	VIN/VOUT = 3.6 to 5	/IN/VOUT = 3.6 to 5.5 V		_	±10.0	μА			
Increase in I _{CC} per inp	out	Δlcc	V _{IH} = V _{CC} - 0.6 V (per 1 input)		2.7 to 3.6	_	500				



AC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Characteristics Symbol Test Condition			Min	Max	Unit
Characteristics	Symbol	rest Condition	V _{CC} (V)	IVIIII	IVIAX	Unit
			1.8 ± 0.15		25.0	
Propagation delay time	t _{pLH}	Figure 1, Figure 2	2.5 ± 0.2		8.5	ns
Propagation delay time	t _{pHL}	rigule 1, rigule 2	2.7	_	7.5	115
			3.3 ± 0.3	1.5	6.5	
	t _{pZL} t _{pZH}	Figure 1, Figure 3	1.8 ± 0.15	_	34.0	ns
Outside south time			2.5 ± 0.2	_	17.0	
Output enable time			2.7	_	9.5	
			3.3 ± 0.3	1.5	8.5	
	t _{pLZ} t _{pHZ}	Figure 1, Figure 3	1.8 ± 0.15		32.0	
Output disable time			2.5 ± 0.2	_	16.0	ns
			2.7	_	8.5	115
			3.3 ± 0.3	1.5	7.5	
Output to output skow	tosLH	(1)	2.7	_		
Output to output skew tosHL (Note)	3.3 ± 0.3	_	1.0	ns		

Note: Parameter guaranteed by design.

(tosLH = |tpLHm - tpLHn|, tosHL = |tpHLm - tpHLn|)

Dynamic Switching Characteristics (Ta = 25°C, input: tr = tf = 2.5 ns, CL = 50 pF, RL = 500 Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	VOLP	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
Quiet output minimum dynamic V _{OL}	Volv	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}	_	3.3	7	pF
Output capacitance	Cout	_	3.3	8	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (Note)	3.3	40	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

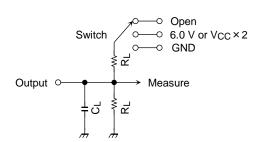
Average operating current can be obtained by the equation:

ICC (opr) = $CPD \cdot VCC \cdot fIN + ICC/8$ (per bit)

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AC Test Circuit



Parameter	Switch		
tpLH, tpHL	Open		
+ . - + - .	6.0 V @ V _{CC} =3.3±0.3 @ V _{CC} =2.7V		
t _{pLZ} , t _{pZL}	V _{CC} ×2	@ V _{CC} =2.5±0.2V @ V _{CC} =1.8±0.15V	
t _{pHZ} , t _{pZH}	GND		

Figure 1

AC Waveform

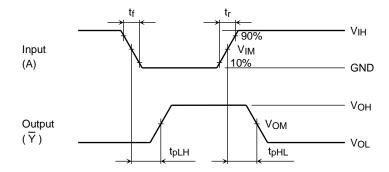


Figure 2 t_{pLH}, t_{pHL}



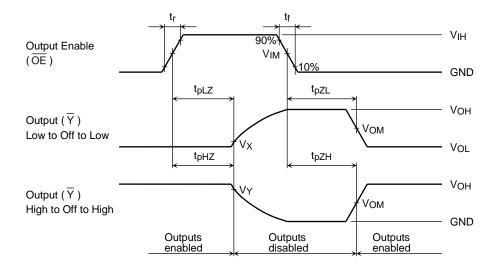


Figure 3 $t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}$

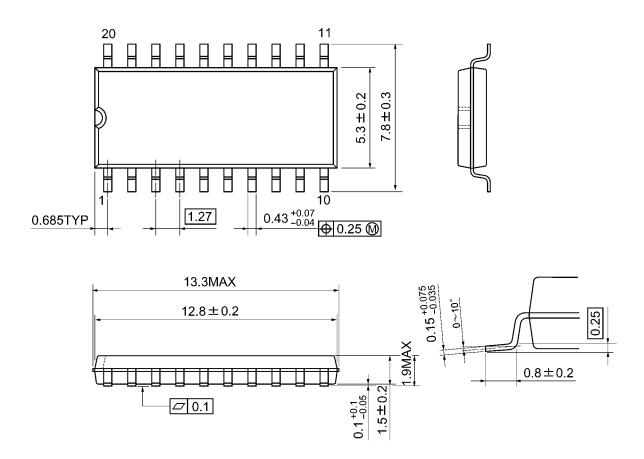
			Vcc	
	Symbol	$3.3 \pm 0.3 \text{ V}$ 2.7 V	2.5 ± 0.2 V	1.8 ± 0.15 V
Input	VIH	2.7 V	Vcc	Vcc
	VIM	1.5 V	Vcc/2	Vcc/2
	t _r , t _f	2.5 ns	2.0 ns	2.0 ns
Output	V _{OM}	1.5 V	V _{OH} /2	V _{OH} /2
	VX	V _{OL} +0.3 V	V _{OL} +0.15 V	V _{OL} +0.15 V
	VY	V _{OH} -0.3 V	V _{OH} -0.15 V	V _{OH} -0.15 V
Load	CL	50 pF	30 pF	30 pF
	RL	500 Ω	500 Ω	1 kΩ

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Package Dimensions

SOP20-P-300-1.27A Unit: mm

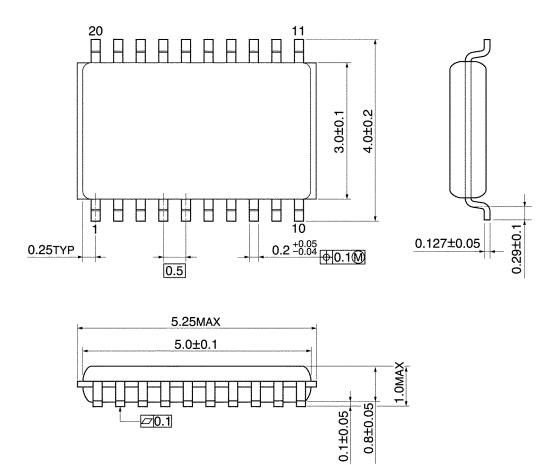


Weight: 0.22 g (typ.)



Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)



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